ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and	mposition De 05. IPC, Bannockt d Pan-American co	c laration ourn, Illinois. A opyright conver	All rights reserved u ntions.	nder both	This docume level parts, th	ent is a declaration en	n of the substanc compasses all lo	es within the man wer level material	ufacturer liste s for which the	d item. Note: if e manufacturer l	the item is an as has engineering	ssembly with low responsibility.	
				Form Type Distribute	 Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi 				Materials and	ials and Mfg Information			
upplier Information													
ompany name*	Company unique ID			l	Unique ID Authority				Response Date*				
onsemi										2025-06-04			
Contact Name Title - Cont			Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards F			Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com			
Authorized Representative* Titl			Title - Representative			Phone - Representative*			Emai	Email - Representative*			
Product-Env-Stewards Pr			Product Enviro Compliance			NA			Prod	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
	KA5H03	KA5H0380RTU FPS		FPS FOR DVDP/STB		2025-06-04		СРА		2528.3484	mg	Each	
Ianufacturing Proccess Infor	mation												
Terminal Plating / Grid Arra	Terminal Plating / Grid Array Material Terminal Base		Alloy J-STD-020 MSL Rating		L Rating	Peak Process Body Temperature Max Tim		ture Max Time a	it Peak Tempe	eak Temperature Number of Reflow Cycles			
Matte Tin (Sn) - annealed		CU Alloy NA		NA		0 C 30		30	sec	seconds 3			
omments													
or more information regarding mate	erial composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chro	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).									
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 4 - Item(s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required Requester) and click on Submit Form to h			e drop-dowi	a. This will display the signature area. Digita	lly sign the declaration (if required by the						
Supplier Digital Signature	astislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	6.19	mg	Supplier	Silicon (Si)	7440-21-3		6.19	mg
Die Attach	1.84	mg	Supplier	Silver (Ag)	7440-22-4		0.0276	mg
			А	Lead (Pb)	7439-92-1	7a	1.7204	mg
			Supplier	Tin (Sn)	7440-31-5		0.092	mg
Lead Frame	1545.11	mg	Supplier	Silver (Ag)	7440-22-4		3.1007	mg
			Supplier	Iron (Fe)	7439-89-6		1.5503	mg
			Supplier	Copper (Cu)	7440-50-8		1539.9956	mg
			Supplier	Phosphorus (P)	7723-14-0		0.4633	mg
Mold Compound-Black	953.4	mg	Supplier	2,6-dibromo-4-[1-(3-bromo-4- hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		28.6	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		191.0003	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		23.8	mg
			Supplier	Carbon Black (C)	1333-86-4		9.534	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		700.4656	mg
Plating	21.6	mg	Supplier	Tin (Sn)	7440-31-5		21.6	mg
Wire Bond - Cu	0.2084	mg	Supplier	Palladium (Pd)	7440-05-3		0.0042	mg
			Supplier	Copper (Cu)	7440-50-8		0.2042	mg